

ON Semiconductor®

FXLA104 Low-Voltage Dual-Supply 4-Bit Voltage Translator with Configurable Voltage Supplies and Signal Levels, 3-State Outputs, and Auto Direction Sensing

Features

- Bi-Directional Interface between Two Levels: from 1.1V to 3.6V
- Fully Configurable: Inputs and Outputs Track V_{CC}
- Non-Preferential Power-Up; Either V_{CC} May Be Powered Up First
- Outputs Switch to 3-State if Either V_{CC} is at GND
- Power-Off Protection
- Bus-Hold on Data Inputs Eliminates the Need for Pull-Up Resistors; Do Not Use Pull-Up Resistors on A or B Ports
- Control Input (/OE) Referenced to V_{CCA} Voltage
- Available in 16-Terminal UMLP (1.8mm x 2.6mm) and 12-Terminal, Quad UMLP, 1.8 x 1.8mm Packages
- Direction Control Not Necessary
- 100Mbps Throughput when Translating Between 1.8V and 2.5V
- ESD Protection Exceeds:
 - 8kV HBM (per JESD22-A114 & Mil Std 883e 3015.7)
 - 2kV CDM (per ESD STM 5.3)

Applications

Cell Phone, PDA, Digital Camera, Portable GPS

Description

The FXLA104 is a configurable dual-voltage supply translator for both uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6V to as low as 1.1V. The A port tracks the V_{CCA} level and the B port tracks the V_{CCB} level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2V, 1.5V, 1.8V, 2.5V, and 3.3V.

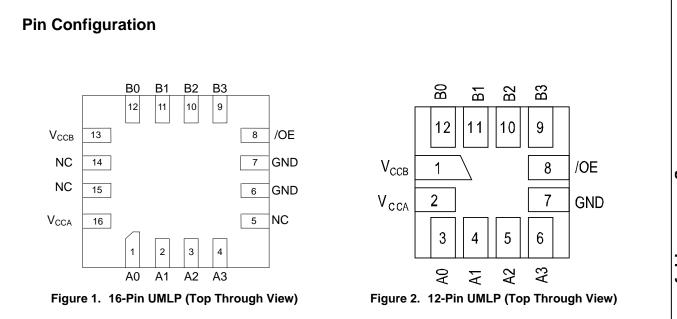
The device remains in three-state as long as either V_{CC} =0V, allowing either V_{CC} to be powered up first. Internal power-down control circuits place the device in 3-state if either V_{CC} is removed.

The /OE input, when HIGH, disables both the A and B ports by placing them in a 3-state condition. The /OE input is supplied by $V_{\text{CCA}}.$

The FXLA104 supports bi-directional translation without the need for a direction control pin. The two ports of the device have auto-direction sense capability. Either port may sense an input signal and transfer it as an output signal to the other port.

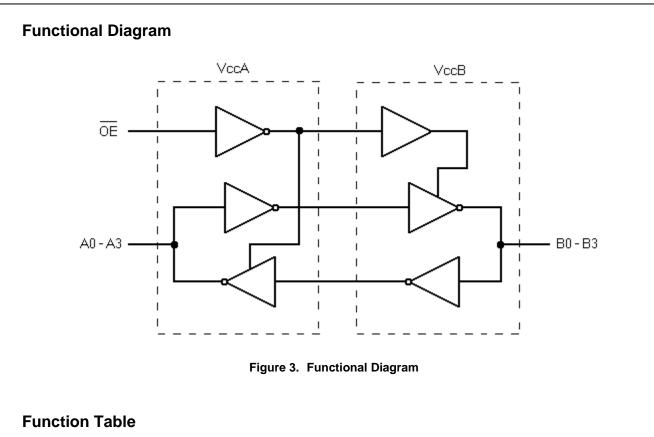
Ordering	Information

Part Number	Operating Temperature Range	Top Mark	Package	Packing Method	
FXLA104UMX	-40 to 85°C	XJ	16-Terminal UMLP 1.8 x 2.6mm Package	5K Units Tape	
FXLA104UM12X	-40 10 85 C	XJ	12-Terminal, Quad UMLP, 1.8 x 1.8mm Package	and Reel	



Pin Definitions

16 Pin #	12 Pin #	Name	Description
1	3	A0	A-Side Inputs or 3-State Outputs
2	4	A1	A-Side Inputs or 3-State Outputs
3	5	A2	A-Side Inputs or 3-State Outputs
4	6	A3	A-Side Inputs or 3-State Outputs
5		NC	No Connect
6,7	7	GND	Ground
8	8	/OE	Output Enable Input
9	9	B3	B-Side Inputs or 3-State Outputs
10	10	B2	B-Side Inputs or 3-State Outputs
11	11	B1	B-Side Inputs or 3-State Outputs
12	12	B0	B-Side Inputs or 3-State Outputs
13	1	V _{CCB}	B-Side Power Supply
14,15		NC	No Connect
16	2	V _{CCA}	A-Side Power Supply



Control	Outputs				
/OE					
LOW Logic Level	Normal Operation				
HIGH Logic Level	3-State				

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
M	Supply Voltogo	V _{CCA}	-0.5	4.6	V	
V _{CC}	Supply Voltage	V _{CCB}	-0.5	4.6	V	
V	DC Input Valtage	I/O Ports A and B	-0.5	4.6	V	
VI	DC Input Voltage	Control Input (/OE)	-0.5	4.6	V	
		Output 3-State	-0.5	4.6		
Vo	Output Voltage ⁽²⁾	Output Active (A _n)	-0.5	V _{CCA} +0.5	V	
		Output Active (B _n)	-0.5	V _{CCB} +0.5		
I _{IK}	DC Input Diode Current	V _{IN} <0V		-50	mA	
	DC Output Diada Current	V ₀ <0V		-50	mA	
I _{ок}	DC Output Diode Current	V _o >V _{cc}		+50	ША	
I _{OH} /I _{OL}	DC Output Source/Sink Curre	ent	-50	+50	mA	
Icc	DC V _{CC} or Ground Current (p	er Supply Pin)		±100	mA	
T _{STG}	Storage Temperature Range		-65	+150	°C	
PD	Power Dissipation			17	mW	
ESD	Electrostatic Discharge	Human Body Model (per JESD22- A114 & Mil Std 883e 3015.7)		8	kV	
E9D	Capability	Charged Device Model (per ESD STM 5.3)		2	ĸν	

Notes:

1. I_O absolute maximum ratings must be observed.

2. All unused inputs and input/outputs must be held at V_{CCi} or GND.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
V _{CC}	Power Supply	Operating V _{CCA} or V _{CCB}	1.1	3.6	V	
M		Ports A and B	0	3.6	V	
V _{IN}	Input Voltage	Control Input (/OE)	0	V _{CCA}	V	
T _A	Operating Temperature, Free Air		-40	+85	°C	
dt/dV	Minimum Input Edge Rate	$V_{CCA/B} = 1.1 \text{ to } 3.6 \text{V}$		10	ns/V	
0	Thermal Resistance:	UMLP-16		315	°C / M	
Θ_{JA}	Junction-to-Ambient	UMLP-12		300	°C/W	
0	Thermal Resistance:	UMLP-16		155	°C/W	
Θ_{JC}	Junction-to-Case	UMLP-12		165	°C/W	

Power-Up/Power-Down Sequence

FXL translators offer an advantage in that either V_{CC} may be powered up first. This benefit derives from the chip design. When either V_{CC} is at 0V, outputs are in a high-impedance state. The control input (/OE) is designed to track the V_{CCA} supply. A pull-up resistor tying /OE to V_{CCA} should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up or power-down. The size of the pull-up resistor is based upon the current-sinking capability of the device driving the /OE pin.

The recommended power-up sequence is:

- 1. Apply power to the first V_{CC} .
- 2. Apply power to the second V_{CC} .
- 3. Drive the /OE input LOW to enable the device.

The recommended power-down sequence is:

- 1. Drive /OE input HIGH to disable the device.
- 2. Remove power from either V_{CC} .
- 3. Remove power from other V_{CC} .

Pull-Up/Pull-Down Resistors

<u>Do not use pull-up or pull-down resistors</u>. This device has bus-hold circuits: pull-up or pull-down resistors are not recommended because they interfere with the output state. The current through these resistors may exceed the hold drive, $I_{I(HOLD)}$ and/or $I_{I(OD)}$ bus-hold currents, resulting in data transition and/or autodirection sensing failures. The bus-hold feature eliminates the need for extra resistors.

DC Electrical Characteristics

 T_A =-40 to 85°C

Symbol	Parameter	Conditions	V _{CCA} (V)	V _{CCB} (V)	Min.	Тур.	Max.	Units
			2.70 to 3.60		2.00			
			2.30 to 2.70		1.60			
VIHA		Data Inputs An Control Pin /OE	1.65 to 2.30	1.10 to 3.60	.65xV _{CCA}			V
		Control 1 III/OL	1.40 to 1.65		$.65 x V_{CCA}$			
			1.10 to 1.40		.90xV _{CCA}			
	High-Level Input Voltage			2.70 to 3.60	2.00			
				2.30 to 2.70	1.60			
VIHB		Data Inputs Bn	1.10 to 3.60	1.65 to 2.30	.65хV _{ссв}			V
				1.40 to 1.65	.65хV _{ссв}			
				1.10 to 1.40	.90xV _{CCB}			
			2.70 to 3.60				.80	
			2.30 to 2.70				.70	
VILA		Data Inputs An Control Pin /OE	1.65 to 2.30	1.10 to 3.60			.35xV _{CCA}	V
		Control PIII/OE	1.40 to 1.65				.35xV _{CCA}	
			1.10 to 1.40				.10xV _{CCA}	
	Low-Level Input Voltage		1.10 to 3.60	2.70 to 3.60			.80	V
				2.30 to 2.70			.70	
VILB		Data Inputs B _n		1.65 to 2.30			.35xV _{CCB}	
				1.40 to 1.65			.35xV _{CCB}	
				1.10 to 1.40			.10xV _{ссв}	
V _{OHA}	High-Level Output	I _{ОН} =-4µА	1.10 to 3.60	1.10 to 3.60	V _{CCA} 4			
V _{OHB}	Voltage ⁽³⁾	I _{ОН} =-4µА	1.10 to 3.60	1.10 to 3.60	V _{CCB} 4			V
V _{OLA}	Low-Level Output	I _{OL} =4µA	1.10 to 3.60	1.10 to 3.60			.4	
V _{OLB}	Voltage ⁽³⁾	I _{OL} =4µA	1.10 to 3.60	1.10 to 3.60			.4	V
		V _{IN} =0.8V	3.00	3.00	75.0			
		V _{IN} =2.0V	3.00	3.00	-75.0			
		V _{IN} =0.7V	2.30	2.30	45.0			
		V _{IN} =1.6V	2.30	2.30	-45.0			
	Bus-Hold Input Minimum	V _{IN} =0.57V	1.65	1.65	25.0			
I _{I(HOLD)}	Drive Current	V _{IN} =1.07V	1.65	1.65	-25.0			μA
		V _{IN} =0.49V	1.40	1.40	11.0			-
		V _{IN} =0.91V	1.40	1.40	-11.0			
		V _{IN} =0.11V	1.10	1.10		4.0		1
		V _{IN} =0.99V	1.10	1.10		-4.0		1

Note:

3. This is the output voltage for static conditions. Dynamic drive specifications are given in the Dynamic Output Electrical Characteristics table.

Continued on following page...

FXLA104 — Low-Voltage Dual-Supply 4-Bit Voltage Translator

DC Electrical Characteristics (Continued)

T_A=-40 to 85°C.

Symbol	Parameter	Conditions	V _{CCA} (V)	V _{CCB} (V)	Min.	Max.	Units	
			3.60	3.60	450.0			
	Bus-Hold Input		2.70	2.70	300.0			
I _{I(ODH)}	Overdrive High	Data Inputs A _n , B _n	1.95	1.95	200.0		μA	
	Current ⁽⁴⁾		1.60	1.60	120.0			
			1.40	1.40	80.0			
			3.60	3.60	-450.0			
	Bus-Hold Input		2.70	2.70	-300.0			
I _{I(ODL)}	Overdrive Low	Data Inputs A _n , B _n	1.95	1.95	-200.0		μA	
	Current ⁽⁵⁾		1.60	1.60	-120.0			
			1.40	1.40	-80.0			
I _I	Input Leakage Current	Control Inputs /OE, V _I =V _{CCA} or GND	1.10 to 3.60	3.60		±1.0	μA	
	Power-Off Leakage	A _n V _O =0V to 3.6V	0	3.60		±2.0		
I _{OFF}	Current	B _n V _O =0V to 3.6V	3.60	0		±2.0	μA	
		$\begin{array}{l} A_n, \ B_n \ V_O = 0 V \ or \ 3.6 V, \\ /OE = V_{IH} \end{array}$	3.60	3.60		±5.0		
I _{oz}	3-State Output Leakage	A _n V _O =0V or 3.6V, /OE=GND	3.60	0		±5.0	μA	
		B _n V _O =0V or 3.6V, /OE=GND	0	3.60		±5.0		
I _{CCA/B}	Quiescent Supply Current ^(6, 7)	V _I =V _{CCI} or GND; I _O =0, /OE=GND	1.10 to 3.60	1.10 to 3.60		10.0	μA	
I _{CCZ}	Current ^(6, 7)	$V_I=V_{CCI}$ or GND; $I_0=0$, /OE= V_{IH}	1.10 to 3.60	1.10 to 3.60		10.0	μA	
I _{CCA}		V _I =V _{CCB} or GND; I _O =0 B-to-A Direction, /OE=GND	0	1.10 to 3.60		-10.0	μA	
	Quiescent Supply	V _I =V _{CCA} or GND; I _O =0 A-to-B Direction	1.10 to 3.60	0		10.0		
I _{CCB}	Current	V _I =V _{CCA} or GND; I _O =0, A-to-B Direction, /OE=GND	1.10 to 3.60	0		-10.0	μA	
		V _I =V _{CCB} or GND; I _O =0 B-to-A Direction	0	1.10 to 3.60		10.0		

Notes:

4. An external drive must source at least the specified current to switch LOW-to-HIGH.

5. An external drive must source at least the specified current to switch HIGH-to-LOW.

6. V_{CCI} is the V_{CC} associated with the input side.

7. Reflects current per supply, V_{CCA} or V_{CCB} .

Dynamic Output Electrical Characteristic

A Port (A_n)

Output Load: C_L=15pF, R_L \ge M Ω (C_{I/O}=4pF), T_A=-40 to 85°C

Symbol	Parameter	V _{CCA} =3.0V to 3.6V		V _{CCA} =2.3V to 2.7V		V _{CCA} =1.65V to 1.95V		V _{CCA} =1.4V to 1.6V		V _{CCA} =1.1V to 1.3V	Units
		Тур.	Max.	Тур.	Max.	Тур.	Max	Тур.	Max.	Тур.	
t _{rise}	Output Rise Time A Port ⁽⁹⁾		3.0		3.5		4.0		5.0	7.5	ns
t _{fall}	Output Fall Time A Port ⁽¹⁰⁾		3.0		3.5		4.0		5.0	7.5	ns
I _{OHD}	Dynamic Output Current High ⁽⁹⁾	-11.4		-7.5		-4.7		-3.2		-1.7	mA
I _{OLD}	Dynamic Output Current Low ⁽¹⁰⁾	+11.4		+7.5		+4.7		+3.2		+1.7	mA

B Port (B_n)

Output Load: C_L=15pF, R_L \ge M Ω (C_{I/O}=5pF), T_A=-40 to 85°C

Symbol	Parameter	V _{CCB} =3.0V to 3.6V		V _{CCB} =2.3V to 2.7V		V _{CCB} =1.65V to 1.95V		V _{CCB} =1.4V to 1.6V		V _{CCB} =1.1V to 1.3V	Units
-		Тур.	Max.	Тур.	Max.	Тур.	Max	Тур.	Max.	Тур.	
t _{rise}	Output Rise Time B Port ⁽⁹⁾		3.0		3.5		4.0		5.0	7.5	ns
t _{fall}	Output Fall Time B Port ⁽¹⁰⁾		3.0		3.5		4.0		5.0	7.5	ns
I _{OHD}	Dynamic Output Current High ⁽⁹⁾	-12.0		-7.9		-5.0		-3.4		-1.8	mA
I _{OLD}	Dynamic Output Current Low ⁽¹⁰⁾	+12.0		+7.9		+5.0		+3.4		+1.8	mA

Notes:

8. Dynamic output characteristics are guaranteed, but not tested.

9. See Figure 8.

10. See Figure 9.

AC Characteristics

$V_{CCA} = 3.0V$ to 3.6V, $T_A = -40$ to 85°C

Symbol	Parameter	V _{CCB} =3.0V to 3.6V		V _{CCB} =2.3V to 2.7V		V _{CCB} =1.65V to 1.95V		V _{CCB} =1.4V to 1.6V		V _{CCB} =1.1V to 1.3V	Units
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Max.	Тур.	
	A to B	0.2	4.0	0.3	4.2	0.5	5.4	0.6	6.8	6.9	ns
t _{PLH} ,t _{PHL}	B to A	0.2	4.0	0.2	4.1	0.3	5.0	0.5	6.0	4.5	ns
t _{PZL} ,t _{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t _{skew}	A Port, B Port ⁽¹¹⁾		0.5		0.5		0.5		1.0	1.0	ns

V_{CCA} = 2.3V to 2.7V, $T_{\text{A}}\text{=-40}$ to 85°C

Symbol	Parameter	V _{CCB} =3.0V to 3.6V		V _{CCB} =2.3V to 2.7V		V _{CCB} =1.65V to 1.95V		V _{CCB} =1.4V to 1.6V		V _{CCB} =1.1V to 1.3V	Units
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Max.	Тур.	
	A to B	0.2	4.1	0.4	4.5	0.5	5.6	0.8	6.9	7.0	ns
t _{PLH} ,t _{PHL}	B to A	0.3	4.2	0.4	4.5	0.5	5.5	0.5	6.5	4.8	ns
t _{PZL} ,t _{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t _{skew}	A Port, B Port ⁽¹¹⁾		0.5		0.5		0.5		1.0	1.0	ns

V_{CCA} = 1.65V to 1.95V, $T_{A}\text{=-40}$ to 85°C

Symbol Parar	Parameter		=3.0V 3.6V		=2.3V 2.7V	V _{CCB} = to 1			=1.4V .6V	V _{CCB} =1.1V to 1.3V	Units
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Max.	Тур.	
	A to B	0.3	5.0	0.5	5.5	0.8	6.7	0.9	7.5	7.5	ns
t _{PLH} ,t _{PHL}	B to A	0.5	5.4	0.5	5.6	0.8	6.7	1.0	7.0	5.4	ns
t _{PZL} ,t _{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t _{skew}	A Port, B Port ⁽¹¹⁾		0.5		0.5		0.5		1.0	1.0	ns

Note:

11. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) *(see Figure 11).* Skew is guaranteed, but not tested.

AC Characteristics (Continued)

$V_{CC}{=}1.4V$ to 1.6V, $T_{A}{=}{-}40$ to $85^{\circ}C$

Symbol	Parameter		=3.0V 3.6V		=2.3V 2.7V	V _{CCB} = to 1			=1.4V I.6V	V _{CCB} =1.1V to 1.3V	Units
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Max.	Тур.	
	A to B	0.5	6.0	0.5	6.5	1.0	7.0	1.0	8.5	7.9	ns
t _{PLH} ,t _{PHL}	B to A	0.6	6.8	0.8	6.9	0.9	7.5	1.0	8.5	6.1	ns
t _{PZL} ,t _{PZH}	/OE to A, /OE to B		1.7		1.7		1.7		1.7	1.7	μs
t _{skew}	A Port, B Port ⁽¹²⁾		1.0		1.0		1.0		1.0	1.0	ns

$V_{CCA}{=}1.1V$ to 1.3V, $T_{A}{=}{-}40$ to $85^{\circ}C$

Symbol	Parameter	V _{ссв} =3.0V to 3.6V Тур.	V _{CCB} =2.3V to 2.7V Typ.	V _{ссв} =1.65V to 1.95V Тур.	V _{ССВ} =1.4V to 1.6V Тур.	V _{CCB} =1.1V to 1.3V Typ.	Units
	A to B	4.6	4.8	5.4	6.2	9.2	ns
t _{PLH} ,t _{PHL}	B to A	6.8	7.0	7.4	7.8	9.1	ns
t _{PZL} ,t _{PZH}	/OE to A, /OE to B	1.7	1.7	1.7	1.7	1.7	μs
t _{SKEW}	A Port, B Port ⁽¹²⁾	1.0	1.0	1.0	1.0	1.0	ns

Note:

12. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) *(see Figure 11).* Skew is guaranteed, but not tested.

Maximum Data Rate^(13, 14)

T_A=-40 to 85°C

V _{CCA}	V _{CCB} =3.0V to 3.6V	V _{CCB} =2.3V to 2.7V	V _{CCB} =1.65V to 1.95V	V _{CCB} =1.4V to 1.6V	V _{CCB} =1.1V to 1.3V	Units
	Min.	Min.	Min.	Min.	Тур.	
V _{CCA} =3.00V to 3.60V	140	120	100	80	40	Mbps
V _{CCA} =2.30V to 2.70V	120	120	100	80	40	Mbps
V _{CCA} =1.65V to 1.95V	100	100	80	60	40	Mbps
V _{CCA} =1.40V to 1.60V	80	80	60	60	40	Mbps
V _{CCA} =1.10V to 1.30V	Тур.	Тур.	Тур.	Тур.	Тур.	
VCCA-1.10V to 1.30V	40	40	40	40	40	Mbps

Notes:

13. Maximum data rate is guaranteed, but not tested.

14. Maximum data rate is specified in megabits per second (see Figure 10). It is equivalent to two times the F-toggle frequency, specified in megahertz. For example, 100Mbps is equivalent to 50MHz.

Capacitance

Symbol	Parameter		Conditions	T _A =+25°C Typical	Units
CIN	Input Capacitance Control I	Pin (/OE)	V _{CCA} =V _{CCB} =GND	3	pF
6		An		4	~ F
C _{I/O}	C _{I/O} Input/Output Capacitance		$V_{CCA}=V_{CCB}=3.3V$, /OE= V_{CCA}	5	pF
C _{pd}	Power Dissipation Capacita	ince	$V_{\text{CCA}}\text{=}V_{\text{CCB}}\text{=}3.3V,V_{\text{I}}\text{=}0V$ or $V_{\text{CC}},f\text{=}10MHz$	25	pF

I/O Architecture Benefit

The FXLA104 I/O architecture benefits the end user, beyond level translation, in the following three ways:

Auto Direction without an external direction pin.

Drive Capacitive Loads. Automatically shifts to a higher current drive mode only during "Dynamic Mode" or HL / LH transitions.

Lower Power Consumption. Automatically shifts to low-power mode during "Static Mode" (no transitions), lowering power consumption.

The FXLA104 does not require a direction pin. Instead, the I/O architecture detects input transitions on both side and automatically transfers the data to the corresponding output. For example, for a given channel, if both A and B side are at a static LOW, the direction has been established as $A \rightarrow B$, and a LH transition occurs on the B port; the FXLA104 internal I/O architecture automatically changes direction from $A \rightarrow B$ to $B \rightarrow A$.

During HL / LH transitions, or "Dynamic Mode," a strong output driver drives the output channel in parallel with a weak output driver. After a typical delay of approximately 10ns – 50ns, the strong driver is turned off, leaving the weak driver enabled for holding the logic state of the channel. This weak driver is called the "bus hold." "Static Mode" is when only the bus hold drives the channel. The bus hold can be over ridden in the event of a direction change. The strong driver allows the FXLA104 to quickly charge and discharge capacitive transmission lines during dynamic mode. Static mode conserves power, where I_{CC} is typically < 5µA.

Bus Hold Minimum Drive Current

Specifies the minimum amount of current the bus hold driver can source/sink. The bus hold minimum drive current (II_{HOLD}) is V_{CC} dependent and guaranteed in the DC Electrical tables. The intent is to maintain a valid output state in a static mode, but that can be overridden when an input data transition occurs.

Bus Hold Input Overdrive Drive Current

Specifies the minimum amount of current required (by an external device) to overdrive the bus hold in the event of a direction change. The bus hold overdrive (II_{ODH} , II_{ODL}) is V_{CC} dependent and guaranteed in the DC Electrical tables.

Dynamic Output Current

The strength of the output driver during LH / HL transitions is referenced on page 8, Dynamic Output Electrical Characteristics, I_{OHD} , and I_{OLD} .

Test Diagrams

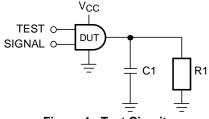




Table 1. AC Test Conditions

Test	Input Signal	Output Enable Control
t _{PLH} , t _{PHL}	Data Pulses	0V
t _{PZL}	0V	HIGH to LOW Switch
t _{PZH}	V _{CCI}	HIGH to LOW Switch

Table 2. AC Load

V _{cCo}	C1	R1
1.2V± 0.1V	15pF	1MΩ
1.5V± 0.1V	15pF	1ΜΩ
$1.8V\pm0.15V$	15pF	1ΜΩ
2.5V ± 0.2V	15pF	1MΩ
$3.3V \pm 0.3V$	15pF	1ΜΩ

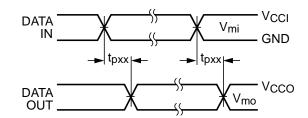
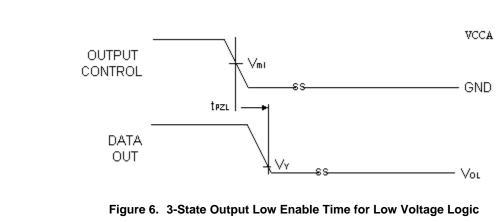


Figure 5. Waveform for Inverting and Non-Inverting Functions

Notes:

15. Input $t_R = t_F = 2.0$ ns, 10% to 90%.

16. Input $t_R = t_F = 2.5$ ns, 10% to 90%, at V₁ = 3.0V to 3.6V only.



Notes:

- 17. Input $t_R = t_F = 2.0$ ns, 10% to 90%.
- 18. Input $t_R = t_F = 2.5$ ns, 10% to 90%, at $V_I = 3.0$ V to 3.6V only.

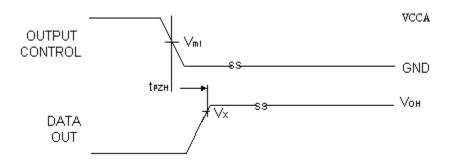


Figure 7. 3-State Output High Enable Time for Low Voltage Logic

Notes:

19. Input $t_R = t_F = 2.0$ ns, 10% to 90%.

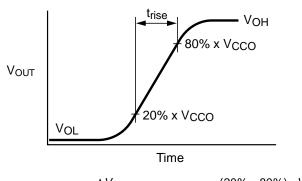
20. Input $t_R = t_F = 2.5ns$, 10% to 90%, at $V_I = 3.0V$ to 3.6V only.

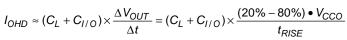
Table 3. Test Measure Points

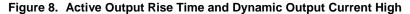
Symbol	V _{DD}
V _{MI} ⁽²¹⁾	V _{CCI} /2
V _{MO}	V _{CCo} /2
V _X	0.9 x V _{CCo}
V _Y	0.1 x V _{CCo}

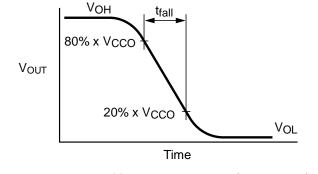
Note:

21. $V_{CCI}=V_{CCA}$ for control pin /OE or $V_{MI}(V_{CCA}/2)$.

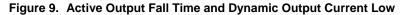


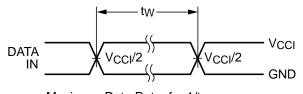






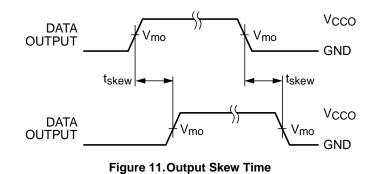
$$I_{OLD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(80\% - 20\%) \bullet V_{CCO}}{t_{FALL}}$$





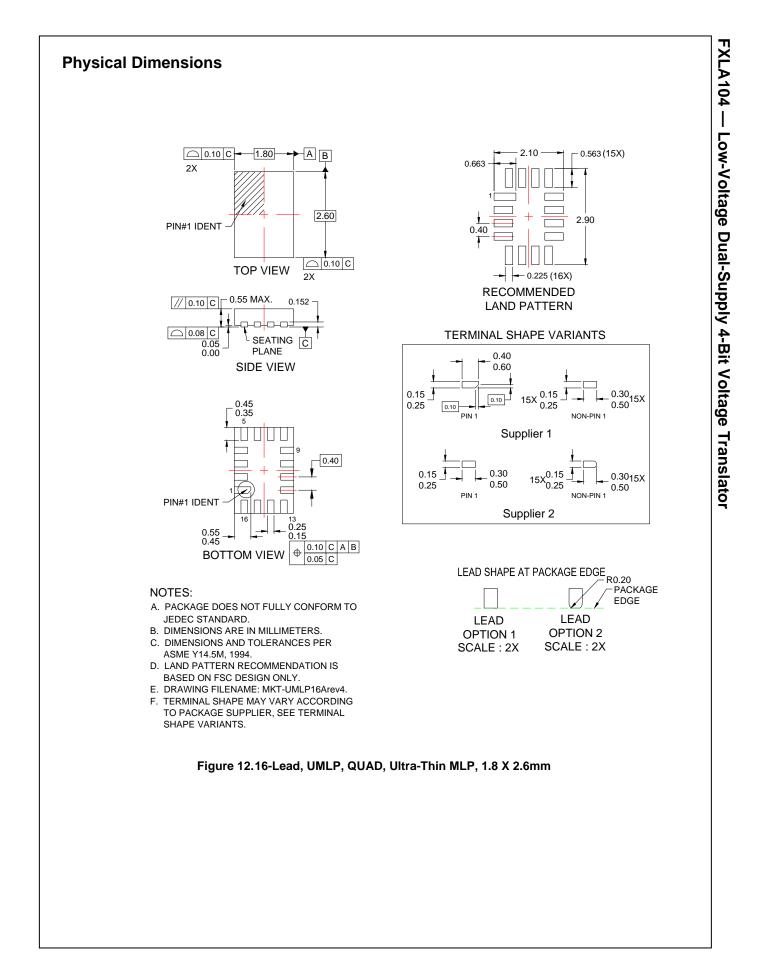
Maximum Data Rate, $f = 1/t_W$

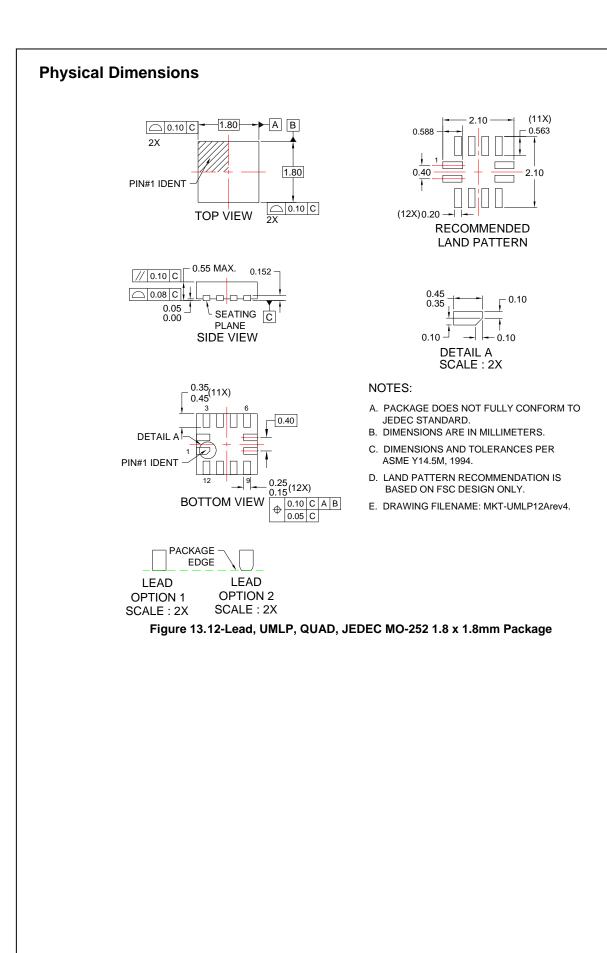
Figure 10. Maximum Data Rate



Note:

22. $t_{SKEW} = (t_{pHLmax} - t_{pHLmin}) \text{ or } (t_{pLHmax} - t_{pLHmin})$





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninten

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: <u>FXLA104UMX</u> <u>FXLA104UM12X</u> <u>FXLA104UM12X-F106</u>